

## Christian Engelmann, Ph.D.

Computer Scientist - Extreme-scale High-Performance Computing  
Computer Science and Mathematics Division, Oak Ridge National Laboratory (ORNL)

✉ P.O. Box 2008, Oak Ridge, TN 37831-6016  
☎ +1 (865) 574-3132 / 📠 +1 (865) 576-5491

🌐 [www.christian-engelmann.info](http://www.christian-engelmann.info)  
✉ [engelmannc@computer.org](mailto:engelmannc@computer.org) / ✉ [engelmannc@ornl.gov](mailto:engelmannc@ornl.gov)

### Professional Accomplishments

12 Research grants (\$29.4M, 4 as lead)	11 Peer-reviewed journal articles	47 Invited talks and seminars
8 Co-advised M.Sc. theses	48 Peer-reviewed conference papers	129 Committees at 41 conferences
4 Mentored summer faculty	37 Peer-reviewed workshop papers	50 Article & book proposal reviews
10 Direct reports over 10 years	8 Peer-reviewed conference posters	11 Conference booth exhibitions
Erdős number of 3	2,380 Total publication citations	H-index of 26 / i10-index of 49

Awards: 2015 US Department of Energy Early Career Award

### Education and Training

2008 : Ph.D. in Computer Science, University of Reading, UK  
2001 : M.Sc. in Computer Science, University of Reading, UK  
2001 : Dipl.-Ing. (FH) in Computer Systems Engineering, University of Applied Sciences Berlin, Germany

### Research and Professional Experience

2009–Present : **R&D Staff Scientist, ORNL**

- Design patterns for a structured approach to resilience at extreme scale
- Taxonomy, catalog and models of faults in extreme-scale systems and applications
- Resilient operating system and runtime software for extreme-scale scientific HPC
- Resilient Monte Carlo solvers with natural fault tolerance for exascale HPC
- HPC hardware/software co-design: performance/resilience/power modeling and simulation
- Soft-error injection for vulnerability analysis of scientific applications
- HPC resiliency system software for monitoring, fault prediction, and fault avoidance
- HPC checkpoint storage virtualization and MPI-level computational redundancy
- Light-weight simulation of extreme scale HPC architectures (~100,000,000 cores)

2012–2015 : **Task Lead of the System Software team, ORNL**

- Co-management of the System Software team (5 R&D Staff Scientists)

2004–2009 : **Associate R&D Staff Scientist, ORNL**

- Fault tolerance for MPI: Scalable membership, job pause, and process migration
- 99.9997% high availability for HPC head/service nodes: Torque and PVFS MDS
- Ph.D. thesis: Symmetric active/active high availability for HPC system services
- Virtual system environments for “plug-and-play” HPC using hypervisors
- Enhancing application development via a common view across platforms

2001–2004 : **Post-Master’s Research Associate, ORNL**

- Harness Distributed Virtual Machine: Pluggable, lightweight, and fault tolerant
- Light-weight simulation of HPC architectures at large scale (~1,000,000 cores)

2000–2001 : **Software Developer, ORNL**

- M.Sc. thesis: Distributed peer-to-peer control for Harness (a fault-tolerant runtime)

### Publications

- [1] M. Snir et al. Addressing failures in exascale computing. *Intl. J. of High Performance Comp. Applications (IJH-PCA)*, 28(2), 2014.
- [2] C. Engelmann. Scaling to a million cores and beyond: Using light-weight simulation to understand the challenges ahead on the road to exascale. *Future Generation Comp. Systems (FGCS)*, 30(0), 2014.
- [3] D. Fiala, F. Mueller, C. Engelmann, K. Ferreira, R. Brightwell, and R. Riesen. Detection and correction of silent data corruption for large-scale high-performance computing. In *Intl. Conf. on High Performance Comp., Networking, Storage and Analysis (SC)*, 2012.

- [4] J. Elliott, K. Kharbas, D. Fiala, F. Mueller, K. Ferreira, and C. Engelmann. Combining partial redundancy and checkpointing for HPC. In *Intl. Conf. on Distributed Comp. Systems (ICDCS)*, 2012.
- [5] C. Wang, F. Mueller, C. Engelmann, and S. Scott. Proactive process-level live migration and back migration in HPC environments. *J. of Parallel and Distributed Comp. (JPDC)*, 72(2), 2012.
- [6] C. Wang, S. Vazhkudai, X. Ma, F. Meng, Y. Kim, and C. Engelmann. NVMalloc: Exposing an aggregate SSD store as a memory partition in extreme-scale machines. In *Intl. Parallel and Distributed Processing Symp. (IPDPS)*, 2012.
- [7] M. Li, S. Vazhkudai, A. Butt, F. Meng, X. Ma, Y. Kim, C. Engelmann, and G. Shipman. Functional partitioning to optimize end-to-end performance on many-core architectures. In *Intl. Conf. on High Performance Comp., Networking, Storage and Analysis (SC)*, 2010.
- [8] X. He, L. Ou, C. Engelmann, X. Chen, and S. Scott. Symmetric active/active metadata service for high availability parallel file systems. *J. of Parallel and Distributed Comp. (JPDC)*, 69(12), 2009.
- [9] A. Nagarajan, F. Mueller, C. Engelmann, and S. Scott. Proactive fault tolerance for HPC with Xen virtualization. In *Intl. Conf. on Supercomputing (ICS)*, 2007.
- [10] C. Engelmann, S. Scott, C. Leangsuksun, and X. He. Symmetric active/active high availability for high-performance computing system services. *J. of Computers (JCP)*, 1(8), 2006.

### **Synergistic Activities**

- 2010–Present : PC chair: Workshop on Latest Advances in Scalable Algorithms for Large-Scale Systems (ScalA) at the Intl. Conf. on High Perf. Comp., Networking, Storage and Analysis (SC)
- 2009–Present : PC chair: Workshop on Resiliency in High-Perf. Comp. at Euro-Par/HPDC/CCGrid
- 2017 : Program co-chair: IEEE Intl. Conf. on Networking, Architecture, and Storage (NAS)
- 2013–2015 : Member of the U.S. Department of Energy’s Technical Council on HPC Resilience

### **Professional Memberships**

USENIX, ACM + SIGHPC/SIGOPS, IEEE + ComSoc/CS/RL, IEEE CS TCFT/TCDP/TCPP/TCSC, SIAM

### **Collaborators and Co-editors (Past 48 Months, Excl. Advisors, Advisees, Junior Pers., and Non-US)**

J. Abraham (UT Austin), F. Aderholdt (TN Tech), S. Adve (UIUC), S. Alam (SNSC), D. Arnold (UNM), S. Arunagiri (UTEP), S. Bagchi (Purdue U), C. Baker (ServiceMesh), P. Balaji (ANL), B. Barrett (SNL), J. Belak (LLNL), M. Benzi (Emory U), S. Borkar (Intel), P. Bose (IBM), J. Brandt (SNL), E. Brewer (UC Berkeley), P. Bridges (UNM), R. Brightwell (SNL), A. Butt (VA Tech), K. Cameron (VA Tech), F. Cappello (ANL), B. Carlson (IDA), Z. Chen (UC Riverside), A. Chien (U Chicago), R. Clay (SNL), P. Coteus (IBM), N. Debardeleben (LANL), D. Dillow (Google), P. Dinda (Northwestern U), P. Diniz (USC), J. Dongarra (UTK), G. Eisenhauer (GA Tech), J. Elliott (NCSU), M. Elnozahy (KAUST), M. Erez (UT Austin), S. Fazzari (Booz Allen), K. Ferreira (SNL), D. Fiala (NCSU), A. Gavrilovska (GA Tech), A. Gentile (SNL), S. Ghafoor (TN Tech), X. Gu (NCSU), R. Gupta (ANL), S. Gurumurthi (AMD), P. Hargrove (LBNL), R. Harrison (Stony Brook U), S. Hemmert (SNL), M. A. Heroux (SNL), S. Hofmeyr (LBNL), C. Iancu (LBNL), B. Jacob (UMD), C. Janssen (Google), J. Jia (LinkedIn), F. Johnson (SAIC), I. Jones (Ocado, UK), G. B. Kandiraju (IBM), L. Kaplan (Cray), S. W. Keckler (NVIDIA), K. Kharbas (NCSU), S. Krishnamoorthy (PNNL), J. Kubiatowicz (UC Berkeley), P. Kudva (IBM), M. Lagadapati (NCSU), I. Laguna (LLNL), M. Lang (LANL), J. Lange (U Pitt), J. Laros (SNL), C. Leangsuksun (LA Tech), S. Leyffer (ANL), M. Li (IBM), D. Liberty (AMD), J. Lofstead (SNL), D. Lowenthal (UAZ), B. Lucas (USC), A. Lumsdaine (Indiana U), X. Ma (Qatar CRI), P. McCormick (LANL), F. Meng (NCSU), S. Mitra (Stanford U), F. Mueller (NCSU), T. Munson (ANL), L. Nowell (DOE), R. Numrich (UMN), R. Oldfield (SNL), H. Ong (MIMOS Berhad), M. Paun (LA Tech), K. Pedretti (SNL), R. Riesen (Intel), A. Rodrigues (SNL), E. Roman (LBNL), R. Ross (ANL), K. D. Ryu (IBM), R. Schreiber (HP Labs), M. Schulz (LLNL), K. Schwan (GA Tech), S. Scott (TN Tech), G. Smith (UoR, UK), M. Snir (ANL), V. Sridharan (AMD), J. Stearley (SNL), T. Sterling (Indiana U), B. Still (LLNL), M. Taylor (SNL), P. Teller (UTEP), D. Terpstra (UTK), T. Tsai (NVIDIA), E. Van Hensbergen (ARM), A. Vishnu (PNNL), A. Walker (UMES), R. Wisniewski (Intel), M. Wolf (GA Tech), J. Wu (LBNL)

### **Graduate and Postdoctoral Advisors and Advisees**

Advisors: V. Alexandrov, BSC, Spain; A. Geist, ORNL; U. Metzler, HTW Berlin; S. Scott, TN Tech

Advisees: R. Baumann, TI, Germany; S. Böhm, ORNL; I. Jones, Ocado, UK; F. Lauer, UTK; A. Litvinova, Gresham Comp., UK; B. Könning, TU Berlin; K. Uhlemann, Coca Cola, Germany; M. Weber, TU Dresden